

# **DATASHEET**

# 1.6mm Round Subminiature Chip LED HIR26-21B/L423/CT



#### **Features**

- Small double-end package
- Low forward voltage
- Good spectral matching to Si photo detector
- Package in 8mm tape on 7" diameter reel
- Pb free
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH

#### **Descriptions**

- HIR26-21B/L423/CT is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with spherical top view lens.
- The device is spectrally matched with silicon photodiode and phototransistor.

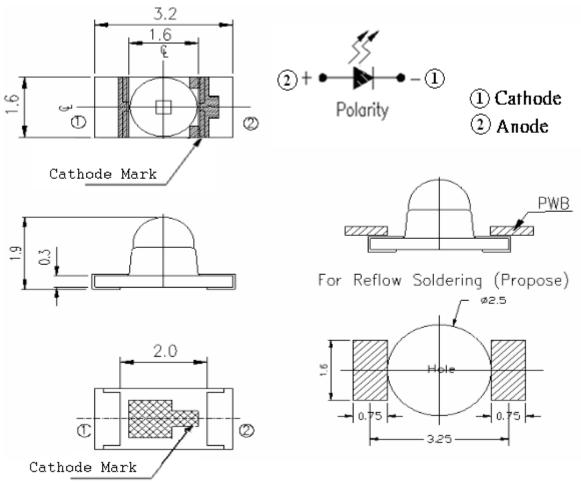
### **Applications**

- PCB mounted infrared sensor
- Infrared remote control units with high power requirement
- Scanner
- · Infrared applied system

#### **Device Selection Guide**

Part Category	Chip Material	Resin Color
HIR	GaAlAs	Black

# **Package Dimensions**



Notes: 1.All dimensions are in millimeters

- 2. Tolerances unless dimensions ±0.1 mm
- 3.Suggested pad dimension is just for reference only
  Please modify the pad dimension based on individual need

**Absolute Maximum Ratings (Ta=25℃)** 

Parameter	Symbol	Rating	Units
Continuous Forward Current	I <sub>F</sub>	50	mA
Reverse Voltage	V <sub>R</sub>	5	V
Operating Temperature	$T_{opr}$	-40 ~ +85	$^{\circ}$
Storage Temperature	$T_{stg}$	-40 ~ +100	$^{\circ}$
Soldering Temperature *1	T <sub>sol</sub>	260	$^{\circ}$
Power Dissipation at (or below) 25℃ Free Air Temperature	P <sub>d</sub>	130	mW

**Notes:** \*1: Soldering time ≤ 5 seconds

**Electro-Optical Characteristics (Ta=25°C)** 

	Liberto Option Ondrastorionos (14-25 C)					
Parameter	Symbol	Condition	Min.	Тур.	Max.	Units
Radiant Intensity	le	I <sub>F</sub> =20mA	10	20		mW/sr
Peak Wavelength	λр	I <sub>F</sub> =20mA	1	850		nm
Spectral Bandwidth	Δλ	I <sub>F</sub> =20mA		30		nm
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =20mA	1.20	1.45	1.70	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V			10	μA
View Angle	2θ1/2	I <sub>F</sub> =20mA		20		deg

**Radiant Intensity Specifications for Bin Grading** 

Rank	Test Condition	Min.	Max.	Units
R		10	15	
S		11	17	
Т		13	20	
U		15	23	
V	I <sub>F</sub> =20mA	17	26	mW /sr
W		20	30	
X		23	34	
Υ		26	40	
Z		>4	10	

**Notes:** This bin table is only for reference, not for specific bin shipment.



# **Typical Electro-Optical Characteristics Curves**

Fig.1 Forward Current vs.

Ambient Temperature

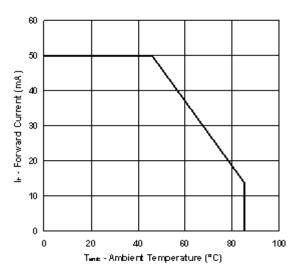
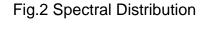


Fig.3 Forward Current vs. Forward Voltage



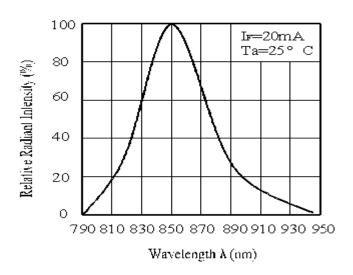
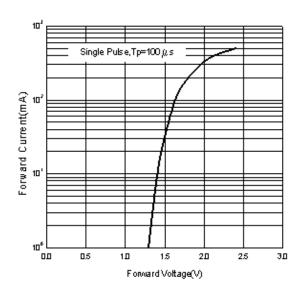
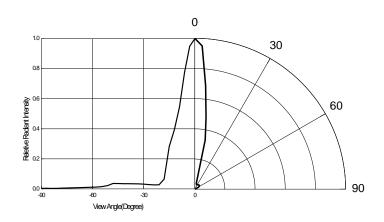


Fig.4 Relative Radiant Intensity vs.

Angular Displacement







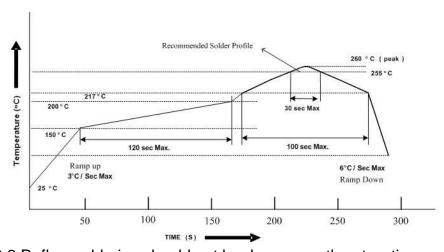
#### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 10 ℃ ~30 ℃ and 90%RH or less.
- 2.3 The LEDs suggested be used within one year.
- 2.4 After opening the package, the devices must be stored at 10°C~30°C and ≤ 60%RH, and used within 168 hours (floor life). If unused LEDs remain, it should be stored in moisture proof packages.
- 2.5 If the moisture absorbent material (desiccant material) has faded or unopened bag haexceeded the shelf life or devices (out of bag) have exceeded the floor life, baking treatment is required.
- 2.6 If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the following conditions:
  - 96 hours at  $60^{\circ}$ C  $\pm 5^{\circ}$ C and < 5 % RH (reeled/tubed/loose units)
- 3. Soldering Condition
  - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

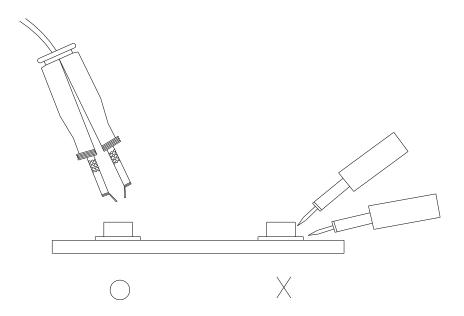


#### 4. Soldering Iron

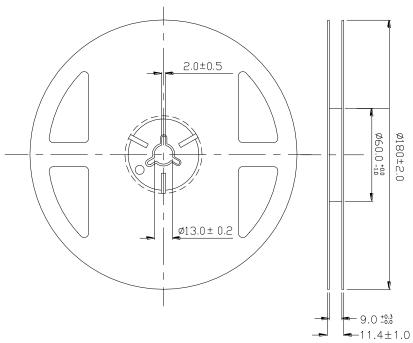
Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

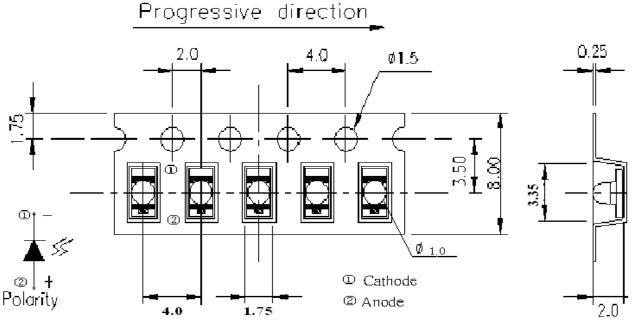


# **Package Dimensions**



**Note:** The tolerances unless mentioned are ±0.1mm, Unit:mm

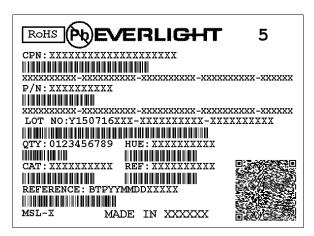
# Carrier Taping Dimensions: Loaded Quantity 1500 PCS/Reel



Note: The tolerances unless mentioned are ±0.1mm, Unit:mm

# **EVERLIGHT**

## **Label Form Specification**



CPN: Customer's Production Number

P/N : Production Number QTY: Packing Quantity

CAT: Ranks

**HUE: Peak Wavelength** 

**REF: Reference** 

LOT No: Lot Number MSL-X: MSL Level

Made In: Manufacture place

#### **Notes**

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 3. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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- 5. This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or life saving applications or any other application which can result in human injury or death. Please contact authorized Everlight sales agent for special application request.

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